3D-Printed Vision-Based Micro-Force Sensor Dedicated to In Situ SEM Measurements

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Abstract—Efficiently working at micro-scale is a difficult task, often requiring a force feedback both accurate and integrated. This paper presents a 3D-printed vision-based microforce sensor intended for measuring inside the chamber of a Scanning Electron Microscope. The use of 3D-printing and highly effective vision-based measurement method allows to design integrated sensors at the cutting edge of the state of the art. Moreover the presented design respects the Abbe's alignment principle. The dimensioning of the mechanism is presented, as well as its processing and its experimental validation under SEM. Periodical patterns are used to measure by vision the differential displacement between the two parts of a flexure. By the knowledge of its stiffness, the force applied on it is measured. Results show a measurement range of 25 μN for a stiffness of 15.3 N.m⁻¹.

I. INTRODUCTION

Efficiently working at micro-scale is a difficult task because of high dynamics, surface forces and more generally unfavourable scaling factor. Despite many of these specificities have been studied, there is still a lack of models and knowledge to estimate and quantify their influence. So it is often required to implement accurate force feedback during experiments. In this way several teams investigated the integration of force sensors, wishing them smaller and closer to the contact.

Most of microforce sensors are based on monolithic elastic microstructures such as cantilevers or beams. Different physical principles have been proposed to measure the position or the deformation of the structure: capacitive [1], [2], [3], piezoresistive [4], [6], [15], strain gauges [7], [8], magnetic [9], and optical [10], [5]. However the research of good resolution is often linked to the design of a low-stiffness compliant mechanism at the expense of dynamics. In most cases, the displacement sensing part of the force sensor is also bulky (see Fig. 1) and can not be placed near the contact point, making the measurement potentially inaccurate. Only a very few of these devices respect the Abbe's alignment principle [17]: whereas the best is to have on the same line (corresponding to the sensitive direction) both the force application point and the sensor, it is often difficult to follow this rule for the design of micro-sensors.



Fig. 1. Resolution of micro-force sensors mentioned in this paper, according to their surface.

Some visual-based approaches have been developed to measure the force by the observation of the deformation of an elastic microstructure that is directly in contact with the object [11], [12]. The use of vision as a force measurement tool has some advantages such as the absence of impact on the compliant mechanism as well as the possibility of measurements along several axes. However these methods are usually limited by the resolution of the camera and by the measurement method used (point detection, correlation, model-based tracking, etc.). Nevertheless it is possible to investigate pattern-based approaches that improve drastically the resolution of visual-based sensing by the use of periodicity [14], [18], [19]. In previous works [16], we applied such approach to force sensing. To date, we obtained a resolution below 50 nN with a centimeter-sized compliant structure with a stiffness of 240 $N.m^{-1}$ and a 10× optical microscope.

Recently, 3D-printing methods have been exploited to process compliant end-effectors used as force sensors by means of vision [13]. Indeed, recent technological advances enable us to consider a new step in the use of vision for micro-force measurements. The dip-in laser lithography is known as an efficient rapid-prototyping technique and is now usable at micro-scale thanks to the two-photon absorption process.

In this paper, we propose to develop a sensor combining the performances of pattern-based approaches to the integration capacities at microscale of 3D-printing. The sensor is also dedicated to be used inside a Scanning Electron

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Fig. 2. The three considered flexures.

Microscope (SEM), a challenging context for force measurement because of the limited space, the restricted number of effective measurement principles and the limited quality of vision.

The proposed visual-based micro-force sensor addresses three objectives:

- to integrate the micro-sensor (see the goal in Fig. 1), including closeness to contact point and respect of Abbe's alignment principle;
- to investigate the suitability of a 3D-printed sensor;
- to operate inside the chamber of a scanning electron microscope (SEM).

The remaining of the paper is organized as follows. Section II describes the sensor concept from it mechanical design to the integration of the patterns. Section III details the mechanical sizing of the compliant structure. Section IV presents the fabrication process and the experimental validation of the sensor. The last section concludes the paper.

II. VISUAL-BASED FORCE SENSING AT THE MICROSCALE

The concept of micro-force sensor further presented allows to measure passively and directly in the direction of the applied force, allowing the respect of the Abbe's alignment principle. In this section we will briefly introduce the flexure mechanism and the method used to obtain displacement measurement based on visual feedback.

A. Flexure systems

To measure the force only applied along one direction, so only the displacement along one direction, the structure of the sensor have to guide the movement. The simplest possible guidance for linear motion consists of using two straight plates connected together with a tip (Fig. 2a). To avoid possible mechanical instabilities in the strips, four clamped plates can be used (Fig. 2b). Instead, a third solution uses four notch hinges (Fig. 2c). The design with four notch hinges defines better the centers of rotation in the kinematics but in the same time concentrates the mechanical stress to these points. In the present case, the material is defined by the dip-in laser lithography process. Since this material has good elastic limit, the design with four clamped plates is preferable.

The stiffnesses of basic flexures are well known and can be calculated with the plate theory of the continuum mechanics [20], [21]. They consist of four clamped plates linking a



Fig. 3. a) Sketch of the concept for the mechanism, b) first CAD model of the mechanism. The non-moving part of the leaf spring acts as a mechanical stop and as reference for the differential measurement.

moving part to a non-moving part with an intermediate rigid body, thus making a leaf spring (see Fig. 3). Since a leaf spring acts like two springs in parallel, the stiffness is the double of the one in shear mode, which gives:

$$K = \frac{1}{\xi(\xi^2 - 3\xi + 3)} \frac{2Ebh^3}{l^3} \tag{1}$$

with b, h and l the main dimensions of the flexure, $\xi = \frac{2l_c}{l}$ the ratio between the length of the two clamped plates and the total length of the spring (a standard value is 0.3), E being the Young Modulus of the material and I being the moment of inertia (which is $\frac{bh^3}{12}$ here).

If a force F is applied on the mechanism, the moving part will move in the direction of application. The restoring force of a spring simply gives the force depending on the stiffness and the displacement of the moving part:

$$F = K\delta \tag{2}$$

with δ the displacement of the moving part when a force F is applied at its tip along x-axis.

B. Phase-difference visual measurement

The use of a SEM as a metrological tool is difficult: images are noised, especially by high frequencies disturbances, and they suffer a drift with time. However a frequency-based



Fig. 4. Analysis of the variations of linear stiffnesses K_y , K_z , $K_{\alpha x}$, $K_{\alpha y}$ and $K_{\alpha z}$ in the domain of all the geometric parameters once all the criteria are taken into account.

method to measure the displacement of a moving part by vision exists that could solve most of the noise problems on the spectral domain. It consists in the use of periodical patterns like a twin set of stripes with the same period. One is positioned on the moving part while the other is on the mechanical stop. These two patterns allow a differential measurement, a need for force measurement that reduces at the same time the impact of image drift [16].

The image processing aims to measure the phase shift that is created between the two sets of stripes with a displacement of the moving part.

This phase shift is related to the displacement by a scalar product in the frequency domain:

$$\mathscr{F}(f(x-\delta)) = e^{-2\pi i \delta \xi}. \quad \mathscr{F}(f(x)) \tag{3}$$

where \mathscr{F} is the Fourier transformation, f(x) is a space function, x the coordinate along the axis, δ the displacement and ξ the reciprocal of x. In this way, a displacement δ of the target induces a phase shift $\Delta \Phi$ in the frequency domain:

$$\Delta \Phi = 2\pi \delta \xi \tag{4}$$

A single-frequency spectral component – corresponding to the spatial frequency of the periodic pattern used – is computed instead of performing a complete Discrete Fourier Transform (DFT) to improve the computation times. For that purpose a complex analysis vector Z(k) is used. It is defined by a Gaussian window and a periodic signal at the period Pof the stripe set (in pixels):

$$Z(k) = e^{-\left(\frac{k-N/2}{N/4.5}\right)^2} \cdot e^{-\left(\frac{2i\pi(k-N/2)}{P}\right)}$$
(5)

with k the pixel index and N the image width in pixels. The phase Φ is then given by the argument of the dot product between vector Z and the vector of pixel intensities.

The phase shift can then be easily converted into the length of the displacement δ of the moving part with:

$$\delta = \frac{\Delta \Phi L}{2\pi} + mL \tag{6}$$

where L is the period of the periodic pattern in meters, $\Delta \Phi$ the phase shift between the sets of stripes and m an integer. It is an ambiguous measure since when the displacement equals a multiple of the period, the phase shift returns to zero due to the periodicity. Thus, this method gives the displacement modulo L. In this paper, it does not cause any problem since the sensor is designed to allow a displacement under or equal to the period but not above.

III. SENSOR DESIGN

A. Determination of the main stiffness

3D printing shows good capabilities to produce complex shapes at micro-scale. Trials show that a period of 4 µm can be obtained through techniques of dip-in laser lithography with a Photonic Professional GT device from Nanoscribe. Displacement can be measured with a resolution of $1/10000^{th}$ of this period (see [16]), provided that approximately 20 periods are visible (to work on a reasonable number of periods, to have a satisfying information redundancy) so for e > 80 µm. Thus the theoretical smallest measurable displacement of the moving part would be 400 pm.



Fig. 5. Length l of the mechanism relatively to its width and thickness for $K = 2.5 \text{ N.m}^{-1}$.

To be able to test our method of force sensing with standard capacitive force sensors, we set ourselves on the objective of realizing a sensor with a resolution of 1 nN. Indeed the equation (2) gives then the desired stiffness of the flexure: $K = 2.5 \text{ N.m}^{-1}$.

In what follows, the device is designed knowing that the material used is a SU-8 resin, the Young Modulus considered is thus E = 2 GPa and the shear modulus is $\sigma_Y = 34$ MPa.

B. Ranges of the Parameters

To achieve this stiffness, the length of the flexure could be calculated now as a function of its width and its thickness through the equation (1):

$$l = \left(\frac{2Ebh^3}{K\xi(\xi^2 - 3\xi + 3)}\right)^{1/3} \tag{7}$$

This function is shown in Fig. 5 for a thickness h varying from 1 μ m to 3 μ m and a width b varying from 10 μ m to 60 μ m.

In Fig. 5 all the values of l are displayed but not all of them are realistic, so some conditions were added. The first condition comes from the plate theory on which calculations are based: $b \ge 10h$ and $l \ge 10h$. Thus the right corner of the surface is removed. It is also important to ensure that the mechanism will not break. Since a mechanical stop was added to the mechanism to prevent the displacement to go beyond the length of one period (which is the range of the unambiguous displacement measurement), the only need is to ensure that the greatest displacement before mechanical break is greater than 4 μ m. The formula for the greatest displacement for the mechanism is:

$$\delta_{max} = \frac{l^2 \sigma_Y}{3Eh} \tag{8}$$

This condition removes the bottom corner of the surface.

All the calculations before only take into account a force applied in the direction of the x axis (the axes are shown in Fig. 3). But even in this case, forces of traction and compression are also applied on the compliant plates in

TABLE I OVERVIEW OF THE DIMENSIONS AND MAIN STIFFNESS OF THE VISUAL-BASED SENSOR.

	$L(\mu m)$	$h(\mu m)$	$b(\mu m)$	$l(\mu m)$	$l_c(\mu m)$	$K(N.m^{-1})$
Theoretical	4	1	49.3	49	7.4	2.5
Obtained	4	1.5	51	47	7	10.1
Characterized						15.3

the z axis unless the force on the x axis is applied at a height of l/2, in which case these unwanted forces negate themselves. This phenomenon can be neglected in a first approximation; however we chose to ensure the validity of this approximation by limiting the ratio l/e, thus diminishing these forces. A maximum ratio of 1 is a reasonable choice, meaning that the plates cannot be longer than the distance between them. This criterion greatly reduces the ranges of the usable geometric parameters. Fig. 4.a shows the possible dimensions for our mechanism.

C. Selection of the Parameters

The mechanism has to allow only a movement along the x axis and blocks the others. To do that, the selected parameters are those which give the highest stiffnesses possible along the other axes. The different stiffnesses are as follow:

$$K_y = \frac{2Ehb^3}{L^3\xi(\xi^2 - 3\xi + 3)} \tag{9}$$

$$K_z = \frac{2Ehb}{L\xi} \qquad (10) \qquad \qquad K_{\alpha x} = \frac{2Ehb^3}{12L\xi} \qquad (11)$$

$$K_{\alpha y} = \frac{Ehb^3}{6L\xi} + 2\left(\frac{e}{2}\right)^2 \frac{Ehb}{L\xi} \tag{12}$$

$$K_{\alpha z} = \frac{Gbh^3}{6L\xi} + 2\left(\frac{e}{2}\right)^2 \frac{Ehb^3}{L^3\xi}$$
(13)

with G being $\frac{E}{2(1+\nu)}$, the shear modulus, and ν being the Poisson ratio (0.33 in this case). K_x , K_y , and K_z are the linear stiffnesses (in N.m⁻¹) of the mechanism respectively along the axes x, y, and z; since K_x is the linear stiffness along the axis of the periodical patterns it has been referred to as simply K. $K_{\alpha x}$, $K_{\alpha y}$, and $K_{\alpha z}$ are the angular stiffnesses (in N.m.rad⁻¹) of the mechanism respectively around the axes x, y, and z. Their values are shown in the Fig. 4 except for K (or K_x) which has already been set at 2.5 N.m⁻¹. It appears clearly that the left corner of the surface, with a maximal value of b and a minimal value of h, maximizes all the stiffnesses. The chosen dimensions are presented in Table I.

IV. EXPERIMENTAL RESULTS

A. Processing

As planned during the dimensioning step, the structure was written using dip-in laser lithography with a Nanoscribe Photonic Professional GT. The $63 \times$ objective and IP-Dip photoresist were used for printing, which allowed for the



Fig. 6. SEM image of the sensor during experiment. Measurement are done with similar videos or images.

highest resolution (< 1 μ m) when writing 3D structures. As the final sensor size was well above the largest block size that could be written with the galvo-scanner (i.e. larger than $150 \times 150 \ \mu$ m² in a horizontal plane), the object was divided in multiple blocks by the Nanoscribe Describe software. To speed up the process, non-critical supporting blocks needed to attach the sensor to the robotic platform, were printed in shell and scaffold mode and fully cured later with a flood UVillumination. The critical block containing the force sensor was written in solid mode. The result can be seen in Fig. 6 and 7.

However the high requirement level initially expected is difficult to achieve. The setup of the Fig. 6 does not respect the theoretical dimensions. The comparison of what we expect and what we obtained is made in Table I. We can see that even if practical dimensions are only slightly different from theoretical, the deducted stiffness is multiplied by 4, reaching 10.1 N.m⁻¹.

B. Stiffness and trueness evaluation

This section deals with the identification of the real stiffness of the compliant mechanism and aims to proof the feasibility of the concept. The sensor was tested under SEM and its measures compared with a capacitive sensor, used as reference.

The visual-based sensor is fixed to a first robotic platform of the SEM. A micro-gripper (FT-G32 from FemtoTools) is controlled by a second robot. Its instrumented finger is used as the reference sensor (see Fig. 6).

A back and forth experiment was completed to evaluate the trueness and the stiffness of the setup. Fig. 8 presents the force measured by the capacitive sensor relatively to the differential displacement measured by vision during three cycles. It allows to evaluate the stiffness of the setup as 15.3 N.m^{-1} . This evaluated stiffness is different from the expected value ($K = 10.1 \text{ N.m}^{-1}$). It could be put down



Fig. 7. SEM images of two critical points of the sensor: its periodic grid and one of its compliant plate.



Fig. 8. Force measured by capacitive sensor relatively to position measurement by vision. Thus the stiffness is evaluated as 15.3 N.m^{-1} .

to the imperfections due to the processing of the setup, on the upper bound of what can be done with dip-in laser lithography methods.

Fig. 9 illustrates the resulting force measurements by vision and by the capacitive sensor. The trueness, taken as the standard deviation of the error, is equal to 0.7 μ N on a global range of 25 μ N. The two force measurements are well-correlated.

The principal limitation of the method is the important stretch even within each image due to the limited scanning speed of the SEM. It often induces a distortion of the image during movements, making a high-resolute measure difficult to obtain. In this way an important improvement of the method could be to reduce this deviation by a better control of the scan, as proposed for example by [22]. Here only two lines are necessary to do the measurement, reducing drastically the scan time and therefore improving the trueness in return for a smaller field of view.



Fig. 9. Force measured by the capacitive sensor and by vision, relatively to the time. The trueness (σ of the error) is measured as 0.7 μ N.

V. CONCLUSION

A new design of passive micro-force sensor by vision is presented. The chosen design is the result of a full mechanical study driven by the wish of effective integration. The method benefits from the advantages of dip-in laser lithography (fast prototyping, monolithic piece, low cost) and from the performances provided by the use of periodical patterns (nanometric measurement of position). The result is a promising highly integrated sensor, with a small size compared to most of other sensors (see Fig. 1).

The trueness was experimentally evaluated to be 0.7 μ N with a capacitive sensor as reference on a global range of 25 μ N. The final stiffness of 15.3 N.m⁻¹ is higher than expected, but the calibration step allows to take it into account for futur designs: a flexure with the required stiffness of 2.5 N.m⁻¹ could be process iteratively, benefiting from the timeliness of 3D-printing process.

The next goal is to improve the resolution while remaining small size, mainly by improving the image quality given by the SEM. Next works will also concern the use of two sensors as end-effectors in one gripper to implement manipulating tasks in SEM without any additional force sensor. The extension to force measurements along more degrees of freedom could also be considered.

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REFERENCES

 R. J. Wood, K.-J. Cho, and K. Hoffman, "A Novel Multi-Axis Force Sensor for Microrobotics Applications," *Smart Materials and Structures*, vol. 18, 2009.

- [2] F. Beyeler, S. Muntwyler, and B. J. Nelson, "A Six-Axis MEMS Force and Torque Sensor With Micro-Newton and Nano-Newtonmeter Resolution," *J. of Microelectromecanical Systems*, vol. 18, no. 2, pp. 433–441, 2009.
- [3] Y. Sun, S. N. Fry, D. P. Potasek, D. J. Bell, and B. J. Nelson, "Characterizing Fruit Fly Flight Behavior Using a Microforce Sensor With a New Comb-Drive Configuration," *J. of Microelectromechanical Systems*, vol. 14, no. 1, pp. 4–11, 2005.
- [4] B. Komati, J. Agnus, C. Clevy, and P. Lutz, "Prototyping of a Highly Performant and Integrated Piezoresistive Force Sensor for Microscale Applications," *J. of Micromechanics and Microengineering*, vol. 24, 2014.
- [5] M. Dienwiebel, E. De Kuyper, L. Crama, and J. W. M. Frenken, "Design and Performance of a High-Resolution Frictional Force Microscope with Quantitative Three-Dimensional Force Sensitivity," *Review of Scientific Instrument*, vol. 76, 2005.
- [6] P. Estevez, J. Bank, M. Porta, J. Wei, P. Sarro, M. Tichem, and U. Staufer, "6 DOF Force and Torque Sensor for Micro-Manipulation Applications," *Procedia Engineering*, vol. 25, pp. 39–42, 2011.
- [7] K. Kristiansen, P. McGuiggan, G. Carver, C. Meinhart, and J. Israelachvili, "3D Force and Displacement Sensor for SFA and AFM Measurements," *Langmuir*, vol. 24, pp. 1541–1549, 2008.
- [8] P. J. Berkelman, L. L. Whitcomb, R. H. Taylor, and P. Jensen, "A Miniature Microsurgical Instrument Tip Force Sensor for Enhanced Force Feedback During Robot-Assisted Manipulation," *IEEE Trans.* on Robotics and Automation, vol. 19, no. 5, pp. 917–922, 2003.
- [9] J. Abadie, E. Piat, S. Oster, and M. Boukallel, "Modeling and Experimentation of a Passive Low Frequency Nanoforce Sensor Based on Diamagnetic Levitation," *Sensors and Actuators A: Physical*, vol. 173, pp. 227–237, 2012.
- [10] X. J. Zhang, S. Zappe, R. W. Bernstein, O. Sahin, C. C. Chen, M. Fish, M. P. Scott, and O. Solgaard, "Micromachined Silicon Force Sensor Based on Diffractive Optical Encoders for Characterization of Microinjection," *Sensors and Actuators A: Physical*, 2004.
- [11] D. J. Cappelleri, G. Piazza, and V. Kumar, "A two dimensional vision-based force sensor for microrobotic applications," *Sensors and Actuators A: Physical*, vol. 171, no. 2, pp. 340–351, 2011.
- [12] R. J. Chang, C. C. Shiu, and C. C. Y., "Self-Biased-SMA Drive PU Microgripper with Force Sensing in Visual Servo," I. J. of Advanced Robotic Systems, vol. 10, 2013.
- [13] M. Power and G. Z. Yang, "Direct laser written passive micromanipulator end-effector for compliant object manipulation," in *IEEE/RSJ Int. Conf. on Intelligent Robots and Systems (IROS)*, 2015, pp. 790–797.
- [14] C. Yamahata, E. Sarajlic, L. Jalabert, M. Kumemura, D. Collard, and H. Fujita, "Mechanical characterization of biomolecules in liquid using silicon tweezers with subnanonewton resolution," in *IEEE 22nd Int. Conf. on Micro Electro Mechanical Systems*. IEEE, 2009, pp. 607– 610.
- [15] M. Billot, X. Xu, J. Agnus, E. Piat, and P. Stempflé, "Multi-axis mems force sensor for measuring friction components involved in dexterous micromanipulation: design and optimisation," *Int. J. of Nanomanufacturing*, vol. 11, no. 3-4, pp. 161–184, 2015.
- [16] V. Guelpa, G. J. Laurent, P. Sandoz, and C. Clévy, "Vision-based microforce measurement with a large range-to-resolution ratio using a twin-scale pattern," *IEEE/ASME Trans. on Mechatronics*, vol. 20, no. 6, pp. 3148–3156, 2015.
- [17] G. X. Zhang, "A study on the Abbe principle and Abbe error," CIRP Annals-Manufacturing Technology, vol. 38(1), pp. 525–528, 1989.
- [18] H. Sugiura, S. Sakuma, M. Kaneko, and F. Arai, "On-chip method to measure mechanical characteristics of a single cell by using moiré fringe," *Micromachines*, vol. 6, no. 6, pp. 660–673, 2015.
- [19] V. Guelpa, G. J. Laurent, P. Sandoz, J. G. Zea, and C. Clevy, "Subpixelic Measurement of Large 1D Displacements: Principle, Processing Algorithms, Performances and Software," *Sensors*, vol. 14, no. 3, pp. 5056–5073, 2014.
- [20] S. Henein, Conception des guidages flexibles. Lausanne, Switzerland: Presses Polytechniques Universitaires Romandes, 2001.
- [21] Y. Bellouard, *Microrobotics: Methods and Applications*. Boca Raton, Florida: CRC Press, 2009.
- [22] T. Tiemerding, C. Diederichs, S. Zimmermann, and S. Fatikow, "Closing the loop: high-speed visual servoing and control of a commercial nanostage inside the SEM," in *Manipulation, Manufacturing and Measurement on the Nanoscale (3M-NANO)*, 2013, pp. 790–797.